



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

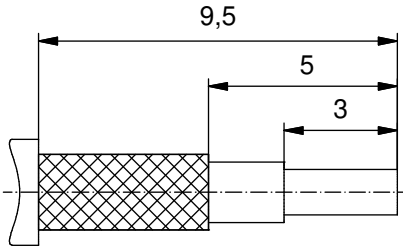
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Stripping dimension/
Kabelvorbereitung:



(C) Technical specification:
Technische Daten:

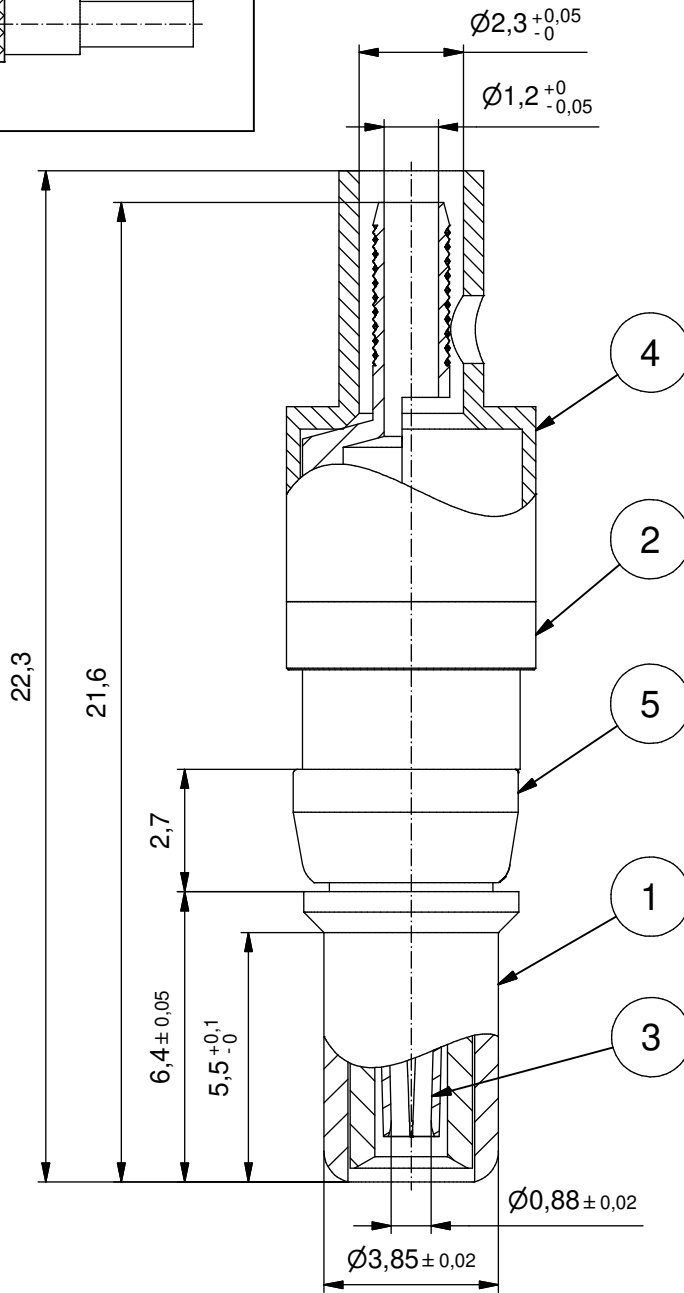
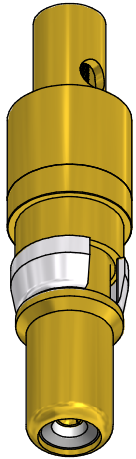
Frequency range/
Frequenzbereich: 0 - 2 GHz

Materials/

Werkstoffe:
Contact/
Kontakt: Cu alloy
Insulator/
Isolator: PTFE

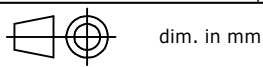
Installation specification/
Montagedaten:

For use with cable/
Für Einsatz mit Kabel: RG 178 B/U
RG 196 A/U
RG 404 /U
Crimp-Tool
for crimp sleeve/
Crimp-Werkzeug
für Crimp-Hülse: 360X10519X
Tool insert/
Werkzeugeinsatz: 360X11019X
Insert cavity/
Einsatznest: C, HEX 2,67 (.105)



(C)

Part no. / Art.-Nr.:	Plating Pos. 1/ Veredelung Pos. 1:	Plating Pos. 2,4/ Veredelung Pos. 2,4:	Plating Pos. 3/ Veredelung Pos. 3:	Plating Pos. 5/ Veredelung Pos. 5:
131A20019X	Gold flash over nickel/ Gold über Nickel	Gold flash over nickel/ Gold über Nickel	Gold flash over nickel/ Gold über Nickel	Nickel plated/ vernickelt
131J20019X	min. 30 µm hard gold over min. 50 µm nickel min. 30 µm Gold über min. 50 µm Nickel	Gold flash over nickel/ Gold über Nickel	min. 50 µm hard gold over min. 50 µm nickel min. 50 µm Gold über min. 50 µm Nickel	Nickel plated/ vernickelt



Coaxial Plug Contact 50 Ohm
Inner conductor solder termination, outer conductor solder or crimp termination

Koaxial Stift Kontakt 50 Ohm
Innenleiter Lötanschluß, Außenleiter Löt- oder Crimpanschluß

	Date/Datum	Name
drawn/ gez.	18.09.2001	E. Mickenbecker
appd./ gepr.	18.09.2001	A. Mickenbecker

Index: c Ä6484 20.01.17 L.U.	scale/Maßstab: 6:1	CONEC®	dwg no / Z.-nr.:	13K2IV6A	DIN- A4
Status: InBearbeitung					
RoHS compliant/konform					1 / 1

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